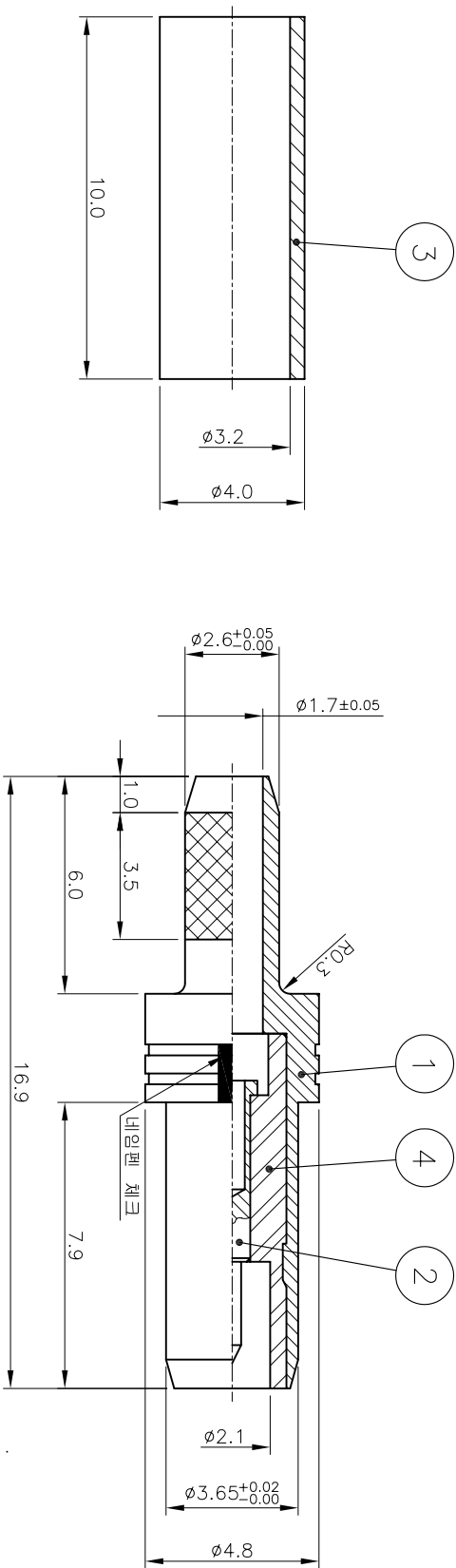


REVISION			DATE
REV	DESCRIPTION		
1R	최초 개정	2009. 07. 24.	



주 기

- 1. 상대를 MALE외경 ø3.65~3.67이며 MAX쪽으로 관리하도록 되어있음.
 - 2. 도금 사양
- 내장용(실내)
- Nickel Plate : 5μm 이상 (BODY,JACK,COVER)
 - Gold Plate : 0.4μm 이상 (CONTACT)
- 외장용 및 수분,유해가스 접촉부
- Gold Plate : 0.4μm 이상 (BODY,CONTACT,JACK,COVER)

4	INSULATOR	1	TEFLON		DIN00311-N/2 (H3138)
3	FERRULE	1	MBSBD	Nickel Plate	DfE00034-5/1 (F3010)
2	CONTACT	1	BeCu	Gold Plate (0.4μm(±))	DCT01157-5/1 (E3176)
1	BODY	1	MBSBD	Nickel Plate (5μm(0.±))	DBD02553-5/1
NO. DESCRIPTION		Q'TY	MATERIAL	PLATING	CODE
DATE 2009. 7. 24.					
APPROVED BY S.J.YOUN					
CHECKED BY I.C.KIM					
DRAWN BY E.H.KIM					
FINISH -					
TOLERANCE		Decimal			
Angle		±0.1			
MATERIAL		±1°			
SCALE 5/1		UNIT mm			
DWG NO. A4		REVISION 1	R	SHEET 1	of 1
TITLE SMB50-JC-316					
KJ COMTECH					
RF & MICROWAVE TECHNOLOGY					
Tel : 82-32-347-8015					
Fax : 82-32-347-8017					